Integrated Device Technology, Inc. 6024 Silver Creek Valley Road San Jose, CA 96138 PRODUCT/PROCESS CHANGE NOTICE (PCN)							
Product Affected: TSE2004GB2 TSE2004GB2 TSE2004GB2 Date Effective: September 15, 20	B0NCG8, B0NCG8/B, B0NCG8/M	,	<ul> <li>MEANS OF DISTINGUISHING CHANGED DEVICES:</li> <li>Product Mark Change in the top mark and orderable part#</li> <li>Back Mark</li> <li>Date Code</li> <li>Other</li> </ul>				
Contact: IDT PCN DESK							
E-mail: pcndesk@idt.co	<u>m</u>	<u>n</u> Samples: Available					
DESCRIPTION AND PURPOSE OF CHANGE:							
<ul> <li>Die Technology</li> <li>Wafer Fabrication Process</li> <li>Assembly Process</li> <li>Equipment</li> <li>Material</li> <li>Testing</li> <li>Manufacturing Site</li> <li>Data Sheet</li> <li>Other</li> </ul>							
	Refer to A	Attachment for qualification	ation report.				
		·	-				
	Current Part# (GF) New Part# (SMIC)						
		E2004GB2B0NCG8		TSE2004GB2C0NCG8			
		E2004GB2B0NCG8		TSE2004GB2C0NCG8/B			
	TS	TSE2004GB2B0NCG8/M TSE2004GB2C0NCG8/M					
<b>RELIABILITY/QUALIFICATIO</b> Wafer and Component level Qualifi reliability of the product. <b>CUSTOMER ACKNOWLEDGM</b>	cation and C	Characterization tests w	ill verify tha	at there is no change to the performance or			
IDT records indicate that you require	re written no nal informat is acceptable version ma	otification of this chang ion. If IDT does not re- e.	ceive acknov	e the acknowledgement below or E-Mail vledgement within 30 days of this notice effective date until the inventory			
Customer: Approval for shipments prior to effective date.							
Name/Date: E-Mail Address:							
Title: Phone# /Fax# :							
CUSTOMER COMMENTS:							
IDT ACKNOWLEDGMENT OF	RECEIPT:						
RECD. BY:			DATE:				



## **Qualification Test Result Summary**

Product: TSE2004GB2C0NCG

Foundry: SMIC

Technology Information: CE018 2P4M

Package Family: VFQFP-N

## Qual Test Result Summary - JESD47 Recommended Tests

Test Description	Conditions	Sample Size	Rejects	Comments
High Temperature Operating Life (Dynamic)	JESD22-A108, +125°C, Vccmax @ 1000 hours or equivalent	77 77 77	0 0 0	
ESD: Human Body Model	JS-001	3	0	2000V
ESD: Charged Device Model	JESD22-C101	3	0	500V
Latch-Up	JESD78	6	0	
Electrical Characterization	Per Datasheet	10*	-	Passed
Elevated Temp NV Cycling Endurance (NVCE)	JESD22-A117 100K cycles @ 85C VCC= Max	77 77 77	0 0 0	
EEPROM Data Retention - High Temperature (HTDR)	JESD22-A117 150C/1000hrs	39 39 39	0 0 0	Samples have been subjected to 100K Elevated Temp NVCE

Note: \* Sample size applies to base characterization



## **Qualification Test Result Summary**

Qualification Test Result Summary – JESD47 Recommended Tests

Test /Conditions	Conditions	Sample Size	Rejects	Comments
Room Temp NV Cycling Endurance (NVCE)	JESD22-A117 100K cycles @ 25C VCC= Max	77 77 77	0 0 0	
EEPROM Data Retention - High Temperature (HTDR*)	JESD22-A117 150C/1000hrs	77 77 77	0 0 0	*Samples have been subjected to 100K Room Temp NVCE
EEPROM Data Retention - High Temperature (HTDR) - Wafer Level*	JESD22-A117 250degC Bake/ 70hrs	1 1 1	0 0 0	To guarantee 10yrs/ 125C based on SMIC process activation energy
Temperature Cycle	JESD22-A104D, -55°C to +125°C, 700 cycles	25 25 25	0 0 0	
High Temperature Storage Bake	JESD22-A-103D, 150°C, 1000 hrs	25 25 25	0 0 0	
Highly Accelerated Stress Test (HAST)	EIA/JESD22-A110D, 130°C/85%R.H. Vcc max for 96 hours	25 25 25	0 0 0	
Moisture Classification	J-STD-020C	25 25	0 0	
Physical Dimensions	JESD22-B100 (Per applicable IDT Package Outline Drawing)	30 30 30	0 0 0	
Solderability Test	JESD22-B102-C, MIL-STD-883 (Method 2003)	5 <sup>1</sup> 5 <sup>2</sup> 5 <sup>3</sup>	0 0 0	<sup>1</sup> Sn/Pb 215°C/5sec <sup>2</sup> Sn/Pb 245°C/5sec <sup>3</sup> Sn 245°C/5sec

Note: For MSL, HAST and Temperature Cycle, samples have been subjected to pre-conditioning per JESD22-A113



## **Qualification Test Result Summary**

Qualification Test Result Summary – JESD47 Recommended Tests

Test /Conditions	Conditions	Sample Size	Rejects	Comments
Ball Shear Test	EIA/JESD22-B116 (IDT Spec MAA-3057)	5 5 5	000	Note 1
Bond Pull Test	IPC-TM-650 (IDT Spec MAC-3010)	5 5 5	0 0 0	Note 1

Note-1: Sub-con data